



10-Dec-2020

## **PACKAGING INFORMATION**

Orderable Device	Status (1)	Package Type	Package Drawing	Pins	Package Qty	Eco Plan	Lead finish/ Ball material	MSL Peak Temp	Op Temp (°C)	Device Marking (4/5)	Samples
MSP430G2444IDA38	ACTIVE	TSSOP	DA	38	40	RoHS & Green	NIPDAU	Level-2-260C-1 YEAR	-40 to 85	M430G2444	Samples
MSP430G2444IDA38R	ACTIVE	TSSOP	DA	38	2000	RoHS & Green	NIPDAU	Level-2-260C-1 YEAR	-40 to 85	M430G2444	Samples
MSP430G2444IRHA40R	ACTIVE	VQFN	RHA	40	2500	RoHS & Green	NIPDAU	Level-3-260C-168 HR	-40 to 85	M430 G2444	Samples
MSP430G2444IRHA40T	ACTIVE	VQFN	RHA	40	250	RoHS & Green	NIPDAU	Level-3-260C-168 HR	-40 to 85	M430 G2444	Samples
MSP430G2444IYFFT	ACTIVE	DSBGA	YFF	49	250	RoHS & Green	SNAGCU	Level-1-260C-UNLIM	-40 to 85	M430G2444	Samples
MSP430G2544IDA38	ACTIVE	TSSOP	DA	38	40	RoHS & Green	NIPDAU	Level-2-260C-1 YEAR	-40 to 85	M430G2544	Samples
MSP430G2544IDA38R	ACTIVE	TSSOP	DA	38	2000	RoHS & Green	NIPDAU	Level-2-260C-1 YEAR	-40 to 85	M430G2544	Samples
MSP430G2544IRHA40R	ACTIVE	VQFN	RHA	40	2500	RoHS & Green	NIPDAU	Level-3-260C-168 HR	-40 to 85	M430 G2544	Samples
MSP430G2544IRHA40T	ACTIVE	VQFN	RHA	40	250	RoHS & Green	NIPDAU	Level-3-260C-168 HR	-40 to 85	M430 G2544	Samples
MSP430G2744IDA38	ACTIVE	TSSOP	DA	38	40	RoHS & Green	NIPDAU	Level-2-260C-1 YEAR	-40 to 85	M430G2744	Samples
MSP430G2744IDA38R	ACTIVE	TSSOP	DA	38	2000	RoHS & Green	NIPDAU	Level-2-260C-1 YEAR	-40 to 85	M430G2744	Samples
MSP430G2744IRHA40R	ACTIVE	VQFN	RHA	40	2500	RoHS & Green	NIPDAU	Level-3-260C-168 HR	-40 to 85	M430 G2744	Samples
MSP430G2744IRHA40T	ACTIVE	VQFN	RHA	40	250	RoHS & Green	NIPDAU	Level-3-260C-168 HR	-40 to 85	M430 G2744	Samples
MSP430G2744IYFFR	ACTIVE	DSBGA	YFF	49	2500	RoHS & Green	SNAGCU	Level-1-260C-UNLIM	-40 to 85	M430G2744	Samples

<sup>(1)</sup> The marketing status values are defined as follows:

**ACTIVE:** Product device recommended for new designs.

**LIFEBUY:** TI has announced that the device will be discontinued, and a lifetime-buy period is in effect.

NRND: Not recommended for new designs. Device is in production to support existing customers, but TI does not recommend using this part in a new design.

**PREVIEW**: Device has been announced but is not in production. Samples may or may not be available.

**OBSOLETE:** TI has discontinued the production of the device.



## PACKAGE OPTION ADDENDUM

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(2) RoHS: TI defines "RoHS" to mean semiconductor products that are compliant with the current EU RoHS requirements for all 10 RoHS substances, including the requirement that RoHS substance do not exceed 0.1% by weight in homogeneous materials. Where designed to be soldered at high temperatures, "RoHS" products are suitable for use in specified lead-free processes. TI may reference these types of products as "Pb-Free".

RoHS Exempt: TI defines "RoHS Exempt" to mean products that contain lead but are compliant with EU RoHS pursuant to a specific EU RoHS exemption.

Green: TI defines "Green" to mean the content of Chlorine (CI) and Bromine (Br) based flame retardants meet JS709B low halogen requirements of <=1000ppm threshold. Antimony trioxide based flame retardants must also meet the <=1000ppm threshold requirement.

- (3) MSL, Peak Temp. The Moisture Sensitivity Level rating according to the JEDEC industry standard classifications, and peak solder temperature.
- (4) There may be additional marking, which relates to the logo, the lot trace code information, or the environmental category on the device.
- (5) Multiple Device Markings will be inside parentheses. Only one Device Marking contained in parentheses and separated by a "~" will appear on a device. If a line is indented then it is a continuation of the previous line and the two combined represent the entire Device Marking for that device.
- (6) Lead finish/Ball material Orderable Devices may have multiple material finish options. Finish options are separated by a vertical ruled line. Lead finish/Ball material values may wrap to two lines if the finish value exceeds the maximum column width.

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